Docket No.: 085027-0104 PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of Customer Number: 89518

Confirmation Number: 8665

Application No.: 10/755,042 Group Art Unit: 2815

Tobi A. Terry

Filed: January 09, 2004 Examiner: Jackson Jr, Jerome

INTEGRATED CHIP PACKAGE STRUCTURE USING SILICON SUBSTRATE AND METHOD OF For: MANUFACTURING THE SAME

TRANSMITTAL

Mail Stop Amendment Commissioner for Patents P.O. Box 1450

Mou-Shiung Lin, et al.

Alexandria, VA 22313-1450

CERTIFICATE OF ELECTRONIC TRANSMISSION I hereby certify that this correspondence is being electronically-transmitted to the United States Patent and Trademark Office on November 16, 2009.

/Tobi A. Terry/

Dear Sir:

Transmitted herewith is an Amendment in the above-identified application.

Also attached: Replacement Drawings (1 Replacement Sheet) and a Petition for a Two-Month Extension of Time

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	46	47	0	\$52.00 =	\$0.00
Independent Claims	3	3	0	\$220.00 =	\$0.00
		Multiple dependent	Multiple dependent claims newly presented		
		Fee for extension of	Fee for extension of time		
			Total of Above Calculations		

 \boxtimes Please charge my Deposit Account No. 502624 in the amount of \$490.00. An additional copy of this transmittal sheet is submitted herewith.

 \boxtimes The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 502624, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

McDERMOTT WILL & EMERY LLP

/Dennis A. Duchene/ Dennis A. Duchene Registration No. 40,595

11682 El Camino Real, Suite 400 San Diego, CA 92130 Phone: 858.720.3300 DAD:tt

Facsimile: 858.720.7800 Date: November 16, 2009 Please recognize our Customer No. 89518 as our correspondence address.